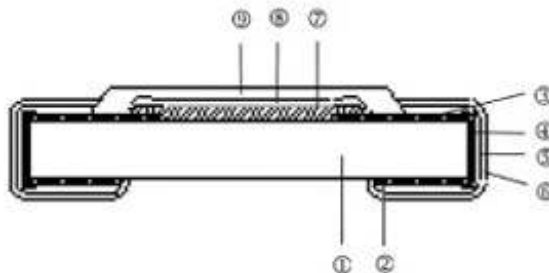
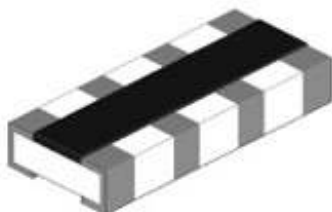


Thick Film Array Chip Resistor – CN-41

Construction



① Alumina Substrate	④ Edge Electrode (Ag)	⑦ Resistor Layer (RuO ₂ /Ag)
② Bottom Electrode (Ag)	⑤ Barrier Layer (Ni)	⑧ Primary Overcoat (Glass)
③ Top Electrode (Ag-Pd)	⑥ External Electrode (Sn)	⑨ Secondary Overcoat (Epoxy)

Features

- Contribute to higher-density mounting and reduction in size of devices by remarkably PCB
- Contribute to the size reduction of small electronic equipment such as Mobile phone, HDD
- Reduced the mounting time by decreasing the number of components
- Suitable for IR reflow soldering

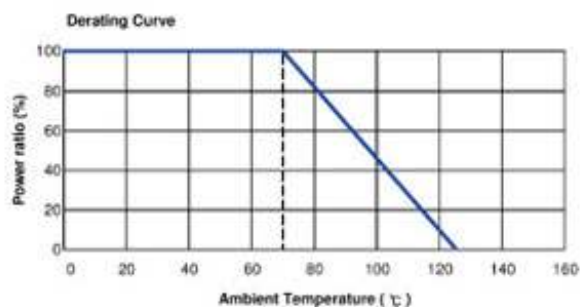
Part Numbering

CN-	41	J	L	6	---1K
Product Type	Dimensions (L×W)	Resistance Tolerance	Function Code	Packaging Code	Resistance
CN-	41: 0201×4	J: ±5%	L: 8P4R	6: 7" Reel 10Kpcs F: Bulk	---1K: 1KΩ ---3K3: 3.3KΩ ---10K: 10KΩ <small>↑ to 10 up to 8 spaces</small>

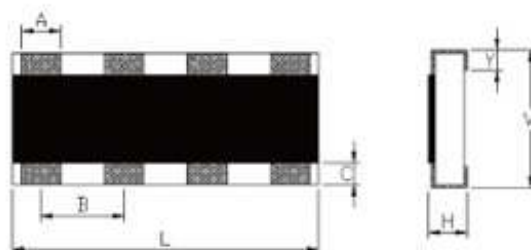
Applications

- Pull-up/pull-down resistors for digital circuits
- Used in interface circuits of LCD displays, memory modules, etc.
- Communication Equipments

Derating Curve



Dimensions



Type	Number of Resistors	L	W	H	A	B	C	Y	Weight (g) (1000pcs)
CN-41	4	1.4±0.10	0.6±0.10	0.35±0.10	0.20±0.10	0.4±0.1	0.1±0.07	0.15±0.05	0.833

Unit: mm

Standard Electrical Specifications

Item Type	Power Rating / Rated Current	Operating Temp. Range	Max. Operating Voltage	Max. Overload Voltage	Number of Resistors	Resistance Range	TCR (PPM/°C)
						±5%	
CN-41	1/32W	-55 ~ +125°C	12.5V	25V	4	10Ω - 1MΩ	±200
Jumper	0.5A					0Ω (<50mΩ)	

Operating Voltage= $\sqrt{P \cdot R}$ or Max. operating voltage Listed above, whichever is lower.

Overload Voltage= $2.5 \cdot \sqrt{P \cdot R}$ or Max. overload voltage Listed above, whichever is lower.

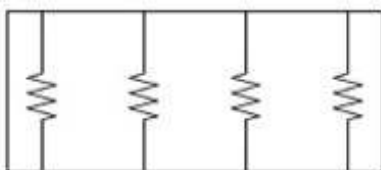
Environmental Characteristics

Item	Requirement		Test Method
	±5%	Jumper	
Temperature Coefficient of Resistance (T.C.R.)	As Spec.		-55°C~+125°C, 25°C is the reference temperature
Short Time Overload	$\pm(2.0\%+0.1\Omega)$	<50mΩ	2.5 times RCWV or Max. overload voltage for 5 seconds
Insulation Resistance	$\geq 10G$		Max. overload voltage for 1 minute
Endurance	$\pm(3.0\%+0.1\Omega)$	<100mΩ	70±2°C, Max. working voltage for 1000 hrs with 1.5 hrs "ON" and 0.5 hrs "OFF"
Damp Heat with Load	$\pm(3.0\%+0.1\Omega)$	<50mΩ	40±2°C, 90~95% R.H., Max. working voltage for 1000 hrs with 1.5 hrs "ON" and 0.5 hrs "OFF"
Dry Heat	$\pm(3.0\%+0.1\Omega)$	<100mΩ	at +125°C for 1000 hrs
Bending Strength	$\pm(1.0\%+0.05\Omega)$	<50mΩ	Bending once for 5 seconds with 3mm
Solderability	>95% coverage		245±5°C for 3 seconds
Resistance to Soldering Heat	$\pm(1.0\%+0.05\Omega)$	<50mΩ	260±5°C for 10 seconds
Voltage Proof	No breakdown or flashover		1.42 times RCWV (RMS) for 1 minute
Rapid Change of Temperature	$\pm(1.0\%+0.05\Omega)$	<50mΩ	-55°C to +125°C, 5 cycles

Reference Standards: IEC 60115-1, 60068-2-58; JIS-C 5201-1

Storage Temperature: 25±3°C; Humidity < 80%RH

Equivalent Circuit Diagram



CN-41

